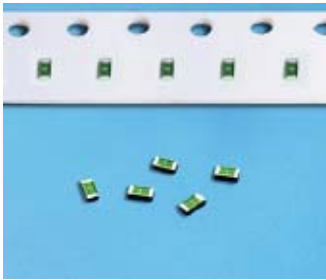


Chip Fuses



Description

- Fast acting for excessive current
- Compatible with reflow and wave solder
- Rugged ceramic and glass construction
- Excellent environmental performance
- RoHS Compliant ,Lead Free & Halogen Free material

Electrical Characteristics

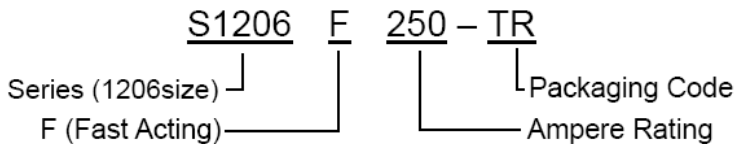
Ampere Rating	% of Amp Rating	Opening Time
250mA-8A	100%	4 Hours Minimum
250mA-8A	250%	5 Seconds Maximum

Application

- Telecommunication: PDA / DSL
- Computers: LCD Panel / Printers/ Laptop/ Servers
- Consumer Electronics: DVD player / MP3 MP4 Player

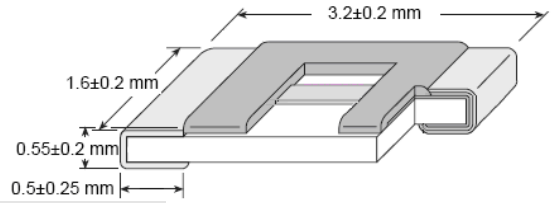
Ordering

- Specify Packaging and product code (i.e. S1206F250-TR)

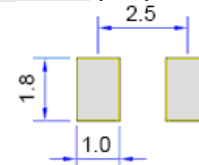


Note: TR: 5,000 pieces of fuses on 8mm tape-and-reel on a 7 inch (178mm) reel per EIA Standard 481

Dimensions



Land Pattern (mm)



Soldering Method

- Wave soldering: 260°C, 10sec max.
- Reflow soldering: 260°C, 30sec max.

Environmental Data

- Life Test: MIL-STD-202, Method 108D
- Humidity Bias: MIL-STD-202, Method 103
- Moisture Resistance Test: MIL-STD-202, Method 106G
- Thermal Shock: MIL-STD-202, Method 107G
- Terminal Strength: AEC-Q200-006
- Board Flex: AEC-Q200-005
- Vibration: MIL-STD-202, Method 204C
- Mechanical Shock: MIL-STD-202, Method 213C
- Solderability: MIL-STD-202 Method 208H
- Resistance to Solder Heat: MIL-STD-202, Method 210B

Electrical Specifications								
Product Code	Current Rating	Voltage Rating		Interrupting Rating*	Resistance (ohms)** Typ.	Typical Melt I ² t *** DC (A ² s)	Typical Voltage Drop (V)****	Alpha Code Marking *****
		AC	DC	AC/DC				
S1206F250	250mA	32V	63V	50A	4.1	0.0004	1.30	D
S1206F375	375mA	32V	63V	50A	2.21	0.0008	0.93	E
S1206F500	500mA	32V	63V	50A	1.5	0.0018	0.76	F
S1206F750	750mA	32V	63V	50A	0.6	0.0055	0.68	G
S1206F1	1A	32V	63V	50A	0.26	0.030	0.32	H
S1206F1.25	1.25A	32V	63V	50A	0.24	0.046	0.27	J
S1206F1.5	1.5A	32V	63V	50A	0.12	0.083	0.19	K
S1206F1.75	1.75A	32V	63V	50A	0.1	0.090	0.18	M
S1206F2	2A	32V	63V	50A	0.072	0.110	0.19	N
S1206F2.5	2.5A	32V	63V	50A	0.051	0.240	0.16	O
S1206F3	3A	32V	63V	50A	0.038	0.255	0.16	P
S1206F3.5	3.5A	32V	32V	50A	0.025	0.280	0.14	R
S1206F4	4A	32V	32V	50A	0.02	0.305	0.13	S
S1206F4.5	4.5A	32V	32V	50A	0.017	0.395	0.12	X
S1206F5	5A	32V	32V	50A	0.016	0.500	0.12	T
S1206F6	6A	32V	32V	50A	0.012	2.064	0.10	Y
S1206F7	7A	32V	32V	50A	0.01	2.720	0.10	U
S1206F8	8A	32V	32V	50A	0.008	4.630	0.10	8

*AC Interrupting Rating (Measured at rated voltage with a unity power factor); DC interrupting rating (Measured at rated voltage, time constant of less than 50 microseconds, battery source)

**DC Cold Resistance (Measured at 10% of rated current)

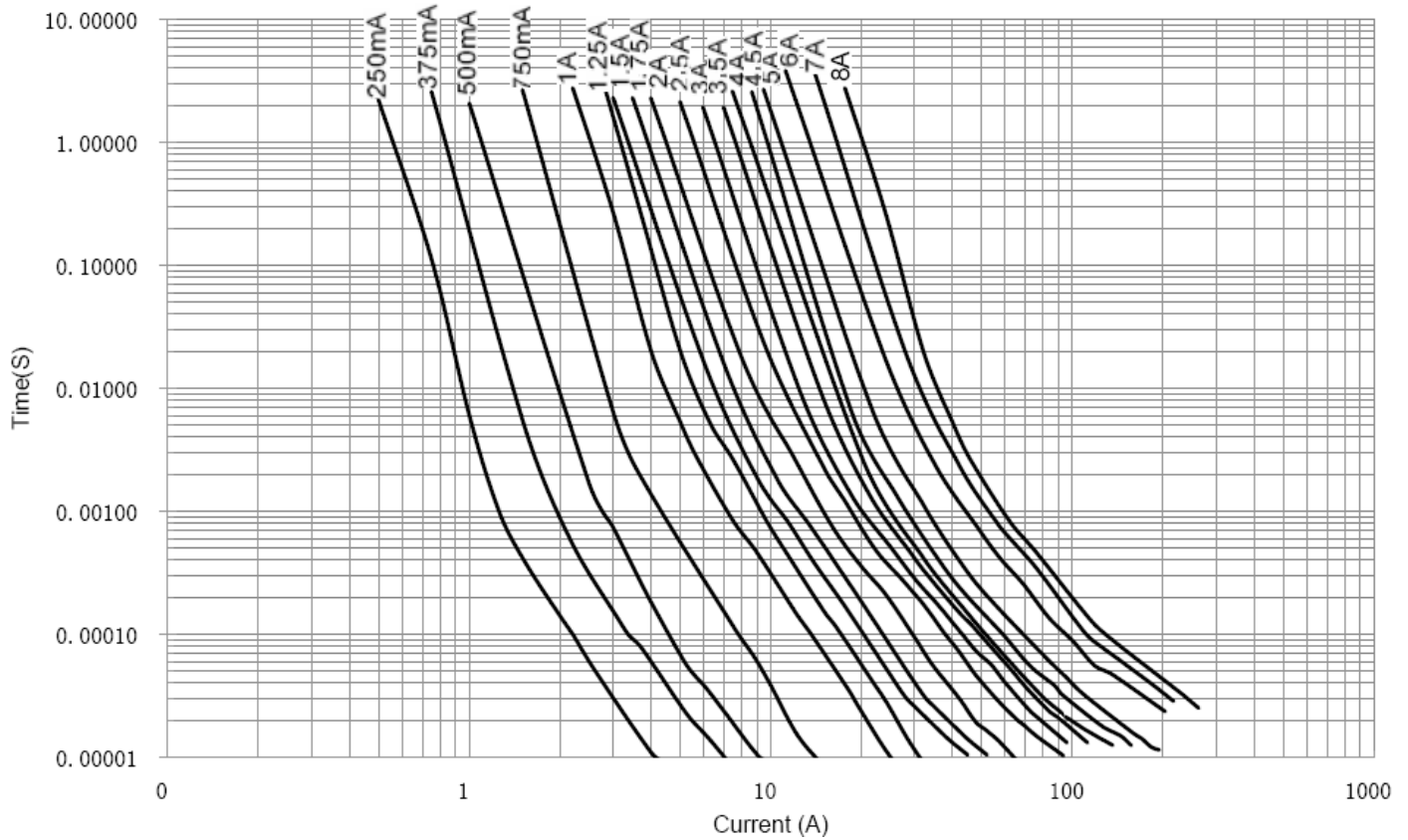
*** Typical Melting I²t (Measured with a battery bank at rated DC voltage, 10x-rated current, not to exceed IR, time constant of calibrated circuit less than 50 microseconds) (6A,7A & 8A measured at interrupting rating)

**** Typical Voltage drop (measured at rated current after temperature stabilizes)

Device designed to carry rated current for four hours minimum. An operating current of 75% or less of rated current is recommended, with further derating required at elevated ambient temperatures.

Chip Fuses

Time Current Curve



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WEBSITE: <http://www.sellifuse.com>